



Product Change Notification

112581 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 112581 - 00
Change Title: Intel® Server System R2312GZ4GC4
PCN 112581-00, Product Design
Update Rear Panel, Add Ground Studs
Date of Publication: September 05, 2013

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *:	Sep 20, 2013
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

Intel has implemented the following changes on Intel® Server System R2312GZ4GC4:

1. Adding a small cut-out to the system rear panel to provide better clearance for latches on network cables plugging into the Dual Port Intel® X540 10GbE I/O Module AXX10GBTWLIOM.
2. Adding two ground studs on the system rear panel for future use (see Figure 1 below).



Figure 1: The ground studs

Customer Impact of Change and Recommended Action:

Intel recommends that the customer perform a standard level of evaluation as updated product becomes available.

Products Affected / Intel Ordering Codes:

EMEA SKU			
Product Code	Change MM#	Pre Change TA	Post Change TA
R2312GZ4GC4	921972	G63765-004	G63765-005

PCN Revision History:

Date of Revision:
September 5, 2013

Revision Number:
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Reason:
Originally Published PCN